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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
(Attorney Docket No. SEM4492P0020US; Corporate Docket No. P98-0025)

the Patent Application of:

Linlin Chen

Serial No.: 09/045,245

Filed: March 20, 1998

For: APPARATUS AND
METHOD FOR
ELECTROLYTICALLY
DEPOSITING COPPER ON A
SEMICONDUCTOR
WORKPIECE

CERTIFICATE OF MAILING

I hereby certify that this
correspondence is being sent via First
Class Mail - Postage Pre-Paid to:
Assistant Commissioner for Patents,
Washington, DC 20231, on January 10,
2000.

Robert B. Polit
Reg. No. 33,993

Examiner: W. Nicolas

Art Unit: 1741

RESPONSE TO THE OFFICE ACTION DATED JULY 9, 1999

Assistant Commissioner for Patents
Washington, D.C. 20231

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JAN 13 2000
FAC 711 2000

Sir:

In response to the Office Action dated July 9, 1999, accompanied by a petition for a
3-month extension of time, please amend the above-identified patent application in the following
manner.

IN THE TITLE:

Please amend the title in the following manner:

APPARATUS AND METHOD FOR ELECTROLYTICALLY DEPOSITING [COPPER]
A METAL ON A [SEMICONDUCTOR] MICROELECTRONIC WORKPIECE

01/19/2000 ASINGLET 00000001 041644 09045245

01 FC:117

870.00 CH.


01/19/2000 ASINGLET 00000003 111410 09045245

468.00
378.00

01 FC:102
02 FC:103

Respectfully submitted,

Date: January 10, 2000

A handwritten signature in black ink, appearing to read "Robert B. Polit", written over a horizontal line.

Robert B. Polit
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Attorney for Applicant

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